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June 2013

QSB363 / QSB363GR / QSB363YR / QSB363ZR Subminiature Plastic Silicon Infrared Phototransistor

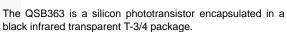
Features

- NPN Silicon Phototransistor
- T-3/4 (2 mm) Surface Mount Package
- Medium Wide Beam Angle: 24°
- Black Plastic Package

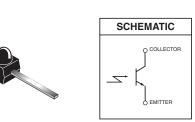
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- Matched Emitters: QEB363 or QEB373
- Daylight Filter
- Tape & Reel Option (see Tape & Reel Specifications)
- Lead Form Options: Gull-wing, Yoke, Z-Bend



Description



Ordering Information

Part Number	Operating Temperature	Package	Packing Method
QSB363		T-3/4	Bulk
QSB363GR	-40 to +85°C	T-3/4 Gull-wing	Tape and Reel
QSB363YR		T-3/4 Yoke	Tape and Reel
QSB363ZR		T-3/4 Z-Bend	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}$ C unless otherwise specified.

Symbol	Parameter	Min.	Unit	
T _{OPR}	Operating Temperature	-40 to +85		
T _{STG}	Storage Temperature	-40 to +85	- °C	
T _{SOL-I}	Soldering Temperature (Iron) ^(1,2)	260		
T _{SOL-F}	Soldering Temperature (Flow) ^(1,2)	260		
V _{CEO}	Collector Emitter Voltage	30		
V _{ECO}	Emitter Collector Voltage	5	V	
P _C	Power Dissipation ⁽³⁾	75	mW	

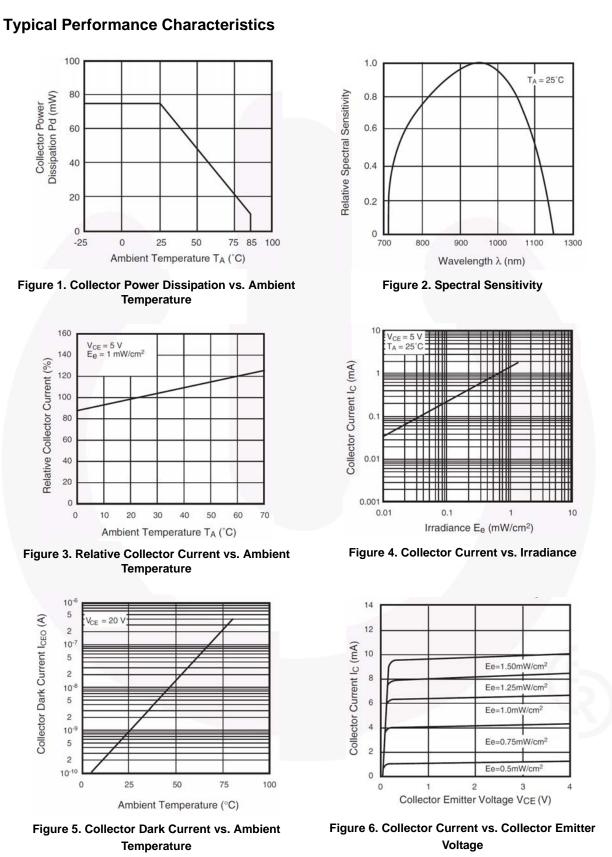
Notes:

- 1. RMA flux is recommended.
- 2. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 3. Derate power dissipation linearly 1.08 mW/°C above 25°C.

Electrical / Optical Characteristics

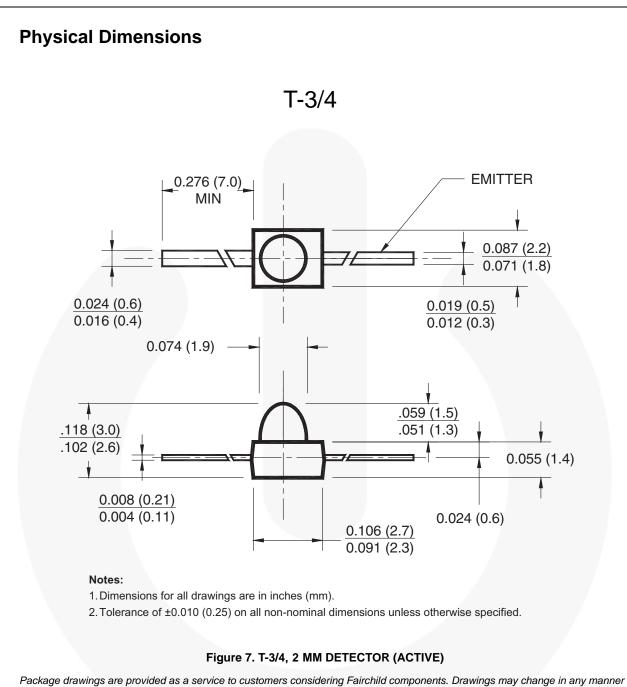
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
λ _P	Peak Sensitivity Wavelength			940		nm
Θ	Reception Angle			±12		0
I _{CEO}	Collector Dark Current	$V_{CE} = 20 V,$ $E_e = 0 mW/cm^2$			100	nA
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 100 \ \mu A,$ $E_e = 0 \ mW/cm^2$	30			V
BV_{ECO}	Emitter-Collector Breakdown Voltage	$I_E = 100 \ \mu A,$ $E_e = 0 \ mW/cm^2$	5			V
I _{C(ON)}	On-State Collector Current	$V_{CE} = 5 V,$ $E_e = 1 mW/cm^2,$ $\lambda = 940 nm GaAs$	1.0	1.5		mA
V _{CE(SAT)}	Collector-Emitter Saturation Voltage	$I_{C} = 2 \text{ mA},$ $E_{e} = 1 \text{ mW/cm}^{2},$ $\lambda = 940 \text{ nm GaAs}$			0.4	V
t _r	Rise Time	$V_{CE} = 5 \text{ V}, I_{C} = 1 \text{ mA},$		15		μs
t _f	Fall Time	R _L = 1000 Ω		15		μs

Values are at $T_A = 25^{\circ}C$ unless specified otherwise.



QSB363 / QSB363GR / QSB363YR / QSB363ZR

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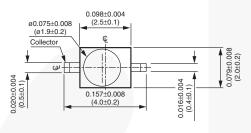
Subminiature Plastic Silicon Infrared Phototransistor

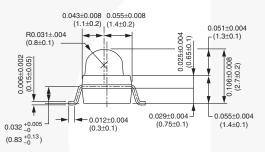
Physical Dimensions (continued)

Features

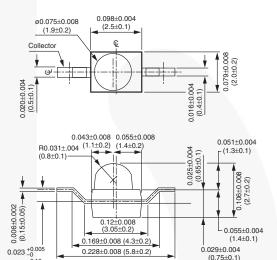
- Three lead forming options: Gull-wing, Yoke and Z-Bend
- Compatible with automatic placement equipment
- Supplied on tape and reel or in bulk packaging
- Compatible with vapor phase reflow solder processes

Gull-wing Lead Configuration

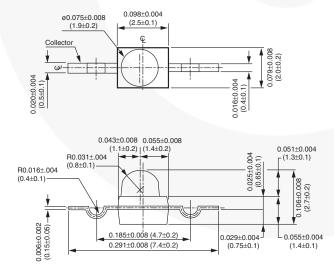




Z-Bend Lead Configuration



Yoke Lead Configuration



(0.6 +0.13)

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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		Rev. 164